

KPGB-0607VBA1SEEKCC-TT

0.65 x 0.65 x 0.25 mm Bi-Color Surface Mount LED

DESCRIPTIONS

- The Blue source color devices are made with InGaN on Sapphire substrate Light Emitting Diode
- The Hyper-Red source color devices are made with AlGaInP on GaAs substrate Light Emitting Diode
- Electrostatic discharge and power surge could damage the LEDs
- It is recommended to use a wrist band or anti-electrostatic glove when handling the LEDs
- All devices, equipments and machineries must be electrically grounded

FEATURES

- 0.65 mm x 0.65 mm SMD LED, 0.25 mm thickness
- Low power consumption
- Package: 4000 pcs / reel
- Moisture sensitivity level: 3
- Halogen-free
- RoHS compliant

APPLICATIONS

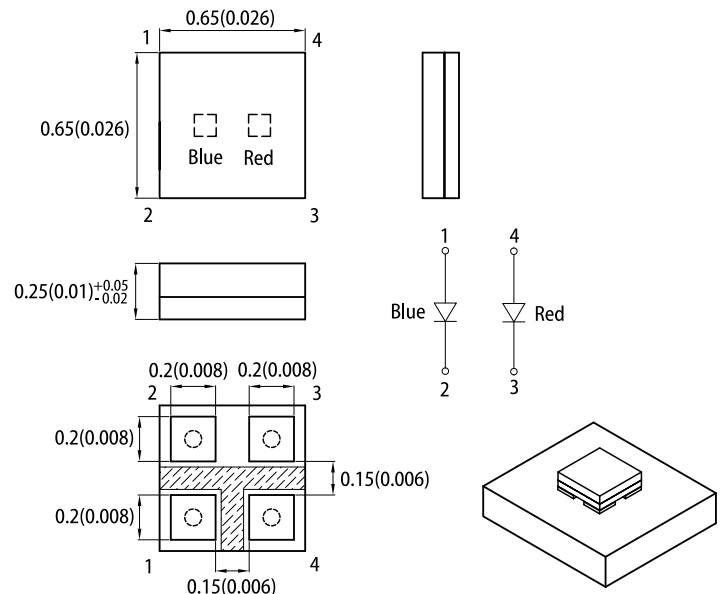
- Backlight
- Status indicator
- Home and smart appliances
- Wearable and portable devices
- Healthcare applications

ATTENTION

Observe precautions for handling electrostatic discharge sensitive devices

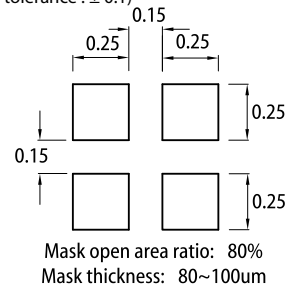


PACKAGE DIMENSIONS



RECOMMENDED SOLDERING PATTERN

(units : mm; tolerance : ± 0.1)



Notes:

1. All dimensions are in millimeters (inches).
2. Tolerance is ±0.1(0.004") unless otherwise noted.
3. The specifications, characteristics and technical data described in the datasheet are subject to change without prior notice.
4. The device has a single mounting surface. The device must be mounted according to the specifications.

SELECTION GUIDE

Part Number	Emitting Color (Material)	Lens Type	Iv (mcd) @ 5mA ^[2]		Viewing Angle ^[1]
			Min.	Typ.	2θ1/2
KPGB-0607VBA1SEEKCC-TT	Blue (InGaN)	Water Clear	10	40	140°
			*10	*40	
	Hyper Red (AlGaInP)		15	75	
			*6	*25	

Notes:
 1. θ1/2 is the angle from optical centerline where the luminous intensity is 1/2 of the optical peak value.
 2. Luminous intensity / luminous flux: ±15%.
 * Luminous intensity value is traceable to CIE127-2007 standards.



ELECTRICAL / OPTICAL CHARACTERISTICS at $T_A=25^{\circ}\text{C}$

Parameter	Symbol	Emitting Color	Value		Unit
			Typ.	Max.	
Wavelength at Peak Emission $I_F = 5\text{mA}$	λ_{peak}	Blue Hyper Red	463 632	-	nm
Dominant Wavelength $I_F = 5\text{mA}$	$\lambda_{\text{dom}}^{[1]}$	Blue Hyper Red	468 624	-	nm
Spectral Bandwidth at 50% Φ REL MAX $I_F = 5\text{mA}$	$\Delta\lambda$	Blue Hyper Red	25 20	-	nm
Forward Voltage $I_F = 5\text{mA}$	$V_F^{[2]}$	Blue Hyper Red	2.9 1.95	3.2 2.3	V
Reverse Current ($V_R = 5\text{V}$)	I_R	Blue Hyper Red	-	50 10	μA
Temperature Coefficient of λ_{peak} $I_F = 5\text{mA}$, $-10^{\circ}\text{C} \leq T \leq 85^{\circ}\text{C}$	$\text{TC}_{\lambda_{\text{peak}}}$	Blue Hyper Red	0.04 0.13	-	nm/ $^{\circ}\text{C}$
Temperature Coefficient of λ_{dom} $I_F = 5\text{mA}$, $-10^{\circ}\text{C} \leq T \leq 85^{\circ}\text{C}$	$\text{TC}_{\lambda_{\text{dom}}}$	Blue Hyper Red	0.03 0.06	-	nm/ $^{\circ}\text{C}$
Temperature Coefficient of V_F $I_F = 5\text{mA}$, $-10^{\circ}\text{C} \leq T \leq 85^{\circ}\text{C}$	TC_V	Blue Hyper Red	-3.0 -1.9	-	mV/ $^{\circ}\text{C}$

Notes:

1. The dominant wavelength (λ_d) above is the setup value of the sorting machine. (Tolerance $\lambda_d: \pm 1\text{nm}$.)
2. Forward voltage: $\pm 0.1\text{V}$.
3. Wavelength value is traceable to CIE127-2007 standards.
4. Excess driving current and / or operating temperature higher than recommended conditions may result in severe light degradation or premature failure.

ABSOLUTE MAXIMUM RATINGS at $T_A=25^{\circ}\text{C}$

Parameter	Symbol	Value		Unit
		Blue	Hyper Red	
Power Dissipation	$P_D^{[1]}$	35		mW
Reverse Voltage	V_R	5	5	V
Junction Temperature	T_j	115	115	$^{\circ}\text{C}$
Operating Temperature	T_{op}	-40 To +85		$^{\circ}\text{C}$
Storage Temperature	T_{stg}	-40 To +100		$^{\circ}\text{C}$
DC Forward Current	$I_F^{[2]}$	10	10	mA
Peak Forward Current	$I_{\text{FP}}^{[3]}$	50	40	mA
Electrostatic Discharge Threshold (HBM)	-	250	3000	V
Thermal Resistance (Junction / Ambient)	$R_{\text{th JA}}^{[4]}$	720	650	$^{\circ}\text{C/W}$
Thermal Resistance (Junction / Solder point)	$R_{\text{th JS}}^{[4]}$	580	480	$^{\circ}\text{C/W}$

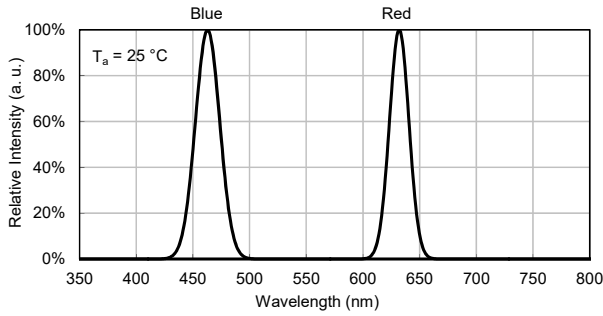
Notes:

1. Within 35mW when multiple chips are lightened
2. The maximum ratings are valid for the case of lighting a single chip
When two chips are lit at the same time, each chip should be driven at a current lower than 50% of the absolute maximum ratings
3. Duty Cycle $\leq 1/20$, Pulse Width = 1ms.
4. $R_{\text{th JA}}, R_{\text{th JS}}$: Results from mounting on PC board FR4 (pad size $\geq 16\text{mm}^2$ per pad).
5. Relative humidity levels maintained between 40% and 60% in production area are recommended to avoid the build-up of static electricity – Ref JEDEC/JESD625-A and JEDEC/J-STD-033.

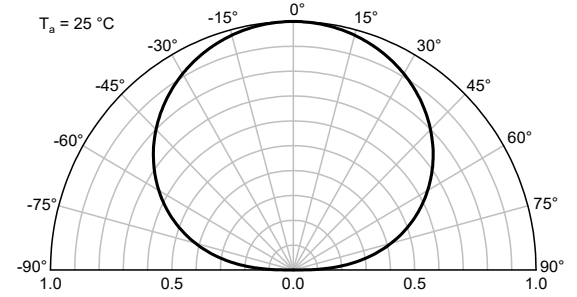


TECHNICAL DATA

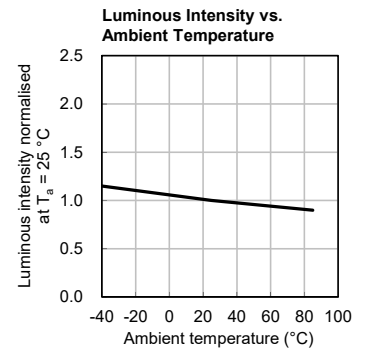
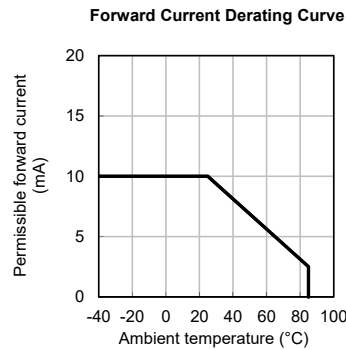
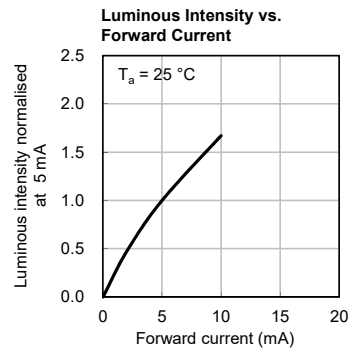
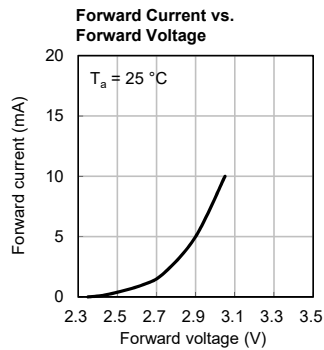
RELATIVE INTENSITY vs. WAVELENGTH



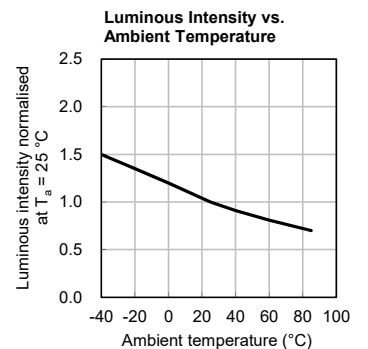
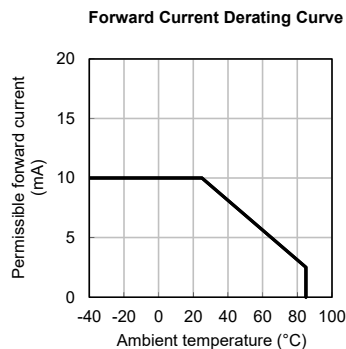
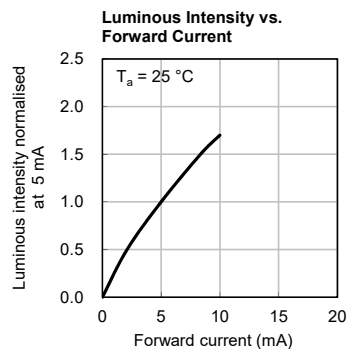
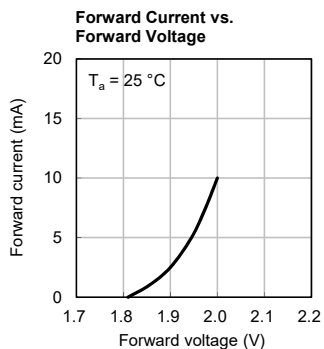
SPATIAL DISTRIBUTION



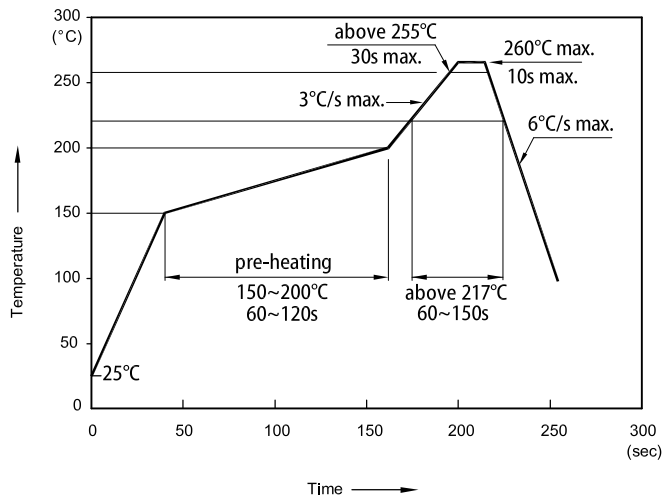
BLUE



HYPER RED

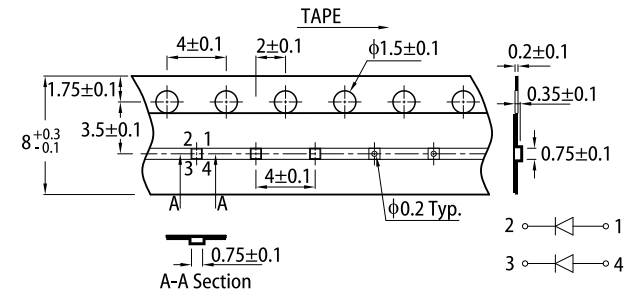


REFLOW SOLDERING PROFILE for LEAD-FREE SMD PROCESS

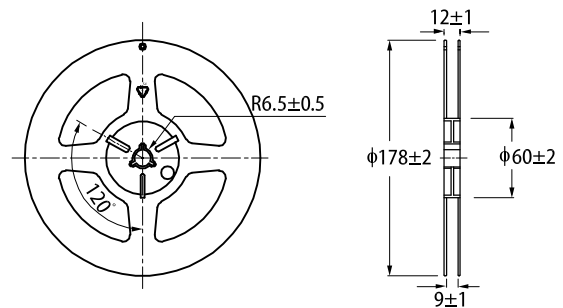


- Notes:
1. Don't cause stress to the LEDs while it is exposed to high temperature.
 2. The maximum number of reflow soldering passes is 2 times.
 3. Reflow soldering is recommended. Other soldering methods are not recommended as they might cause damage to the product.

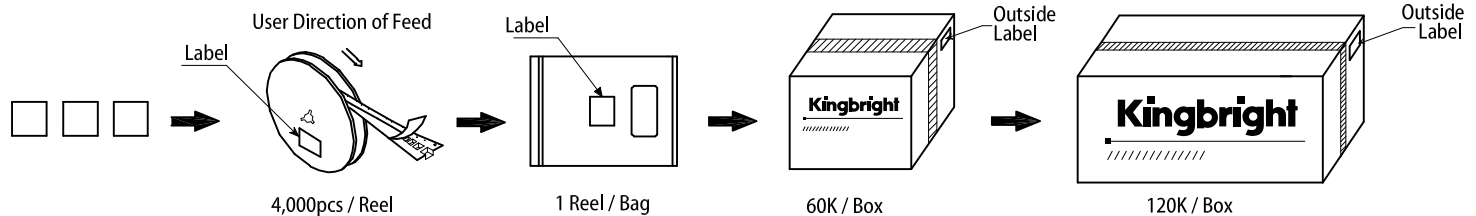
TAPE SPECIFICATIONS (units : mm)



REEL DIMENSION (units : mm)



PACKING & LABEL SPECIFICATIONS



Kingbright

XXXXXXXXXX-XXXX

P/NO: XXXXXXXX

QTY: XXXXXpcs

S/N: XXXX

CODE: XX

COUNTRY: CN

QC DATE: XXX XX XXXX PASSED

LOT NO:

XXXXXXXXXXXXXXX

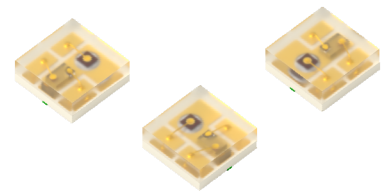
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RoHS Compliant

PRECAUTIONARY NOTES

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2. The part number, type, and specifications mentioned in this document are subject to future change and improvement without notice. Before production usage customer should refer to the latest datasheet for the updated specifications.
3. When using the products referenced in this document, please make sure the product is being operated within the environmental and electrical limits specified in the datasheet. If customer usage exceeds the specified limits, Kingbright will not be responsible for any subsequent issues.
4. The information in this document applies to typical usage in consumer electronics applications. If customer's application has special reliability requirements or have life-threatening liabilities, such as automotive or medical usage, please consult with Kingbright representative for further assistance.
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6. All design applications should refer to Kingbright application notes available at https://www.kingbright.com/application_notes





KPGB-0607VBA1SYKC-TT

0.65 x 0.65 x 0.25 mm Bi-Color Surface Mount LED

DESCRIPTIONS

- The Blue source color devices are made with InGaN on Sapphire substrate Light Emitting Diode
- The Super Bright Yellow source color devices are made with AlGaInP on GaAs substrate Light Emitting Diode
- Electrostatic discharge and power surge could damage the LEDs
- It is recommended to use a wrist band or anti-electrostatic glove when handling the LEDs
- All devices, equipments and machineries must be electrically grounded

FEATURES

- 0.65 mm x 0.65 mm SMD LED, 0.25 mm thickness
- Low power consumption
- Package: 4000 pcs / reel
- Moisture sensitivity level: 3
- Halogen-free
- RoHS compliant

APPLICATIONS

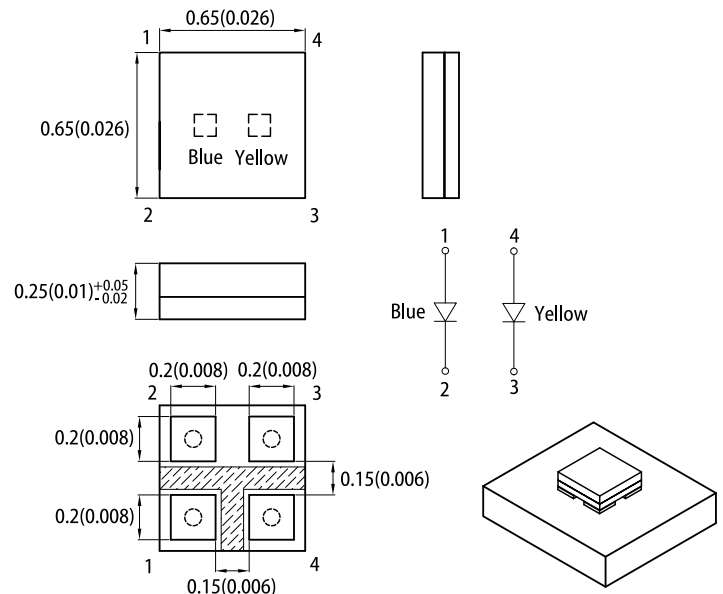
- Backlight
- Status indicator
- Home and smart appliances
- Wearable and portable devices
- Healthcare applications

ATTENTION

Observe precautions for handling electrostatic discharge sensitive devices

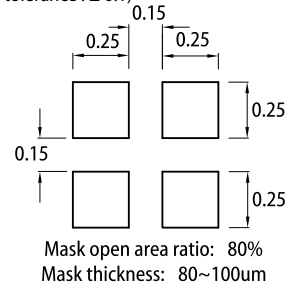


PACKAGE DIMENSIONS



RECOMMENDED SOLDERING PATTERN

(units : mm; tolerance : ± 0.1)



Notes:

1. All dimensions are in millimeters (inches).
2. Tolerance is $\pm 0.1(0.004)$ unless otherwise noted.
3. The specifications, characteristics and technical data described in the datasheet are subject to change without prior notice.
4. The device has a single mounting surface. The device must be mounted according to the specifications.

SELECTION GUIDE

Part Number	Emitting Color (Material)	Lens Type	Iv (mcd) @ 5mA ^[2]		Viewing Angle ^[1]
			Min.	Typ.	2θ1/2
KPGB-0607VBA1SYKC-TT	■ Blue (InGaN)	Water Clear	10	40	140°
	■ Super Bright Yellow (AlGaInP)		4	20	

Notes:

1. θ1/2 is the angle from optical centerline where the luminous intensity is 1/2 of the optical peak value.
2. Luminous intensity / luminous flux: $\pm 15\%$.
3. Luminous intensity value is traceable to CIE127-2007 standards.



ELECTRICAL / OPTICAL CHARACTERISTICS at $T_A=25^{\circ}\text{C}$

Parameter	Symbol	Emitting Color	Value		Unit
			Typ.	Max.	
Wavelength at Peak Emission $I_F = 5\text{mA}$	λ_{peak}	Blue Super Bright Yellow	463 591	-	nm
Dominant Wavelength $I_F = 5\text{mA}$	$\lambda_{\text{dom}}^{[1]}$	Blue Super Bright Yellow	468 589	-	nm
Spectral Bandwidth at 50% Φ REL MAX $I_F = 5\text{mA}$	$\Delta\lambda$	Blue Super Bright Yellow	25 15	-	nm
Forward Voltage $I_F = 5\text{mA}$	$V_F^{[2]}$	Blue Super Bright Yellow	2.9 1.97	3.2 2.3	V
Reverse Current ($V_R = 5\text{V}$)	I_R	Blue Super Bright Yellow	-	50 10	μA
Temperature Coefficient of λ_{peak} $I_F = 5\text{mA}$, $-10^{\circ}\text{C} \leq T \leq 85^{\circ}\text{C}$	$\text{TC}_{\lambda_{\text{peak}}}$	Blue Super Bright Yellow	0.04 0.12	-	nm/ $^{\circ}\text{C}$
Temperature Coefficient of λ_{dom} $I_F = 5\text{mA}$, $-10^{\circ}\text{C} \leq T \leq 85^{\circ}\text{C}$	$\text{TC}_{\lambda_{\text{dom}}}$	Blue Super Bright Yellow	0.03 0.07	-	nm/ $^{\circ}\text{C}$
Temperature Coefficient of V_F $I_F = 5\text{mA}$, $-10^{\circ}\text{C} \leq T \leq 85^{\circ}\text{C}$	TC_V	Blue Super Bright Yellow	-3.0 -2.0	-	mV/ $^{\circ}\text{C}$

Notes:

1. The dominant wavelength (λ_d) above is the setup value of the sorting machine. (Tolerance $\lambda_d: \pm 1\text{nm}$.)
2. Forward voltage: $\pm 0.1\text{V}$.
3. Wavelength value is traceable to CIE127-2007 standards.
4. Excess driving current and / or operating temperature higher than recommended conditions may result in severe light degradation or premature failure.

ABSOLUTE MAXIMUM RATINGS at $T_A=25^{\circ}\text{C}$

Parameter	Symbol	Value		Unit
		Blue	Super Bright Yellow	
Power Dissipation	$P_D^{[1]}$	35		mW
Reverse Voltage	V_R	5	5	V
Junction Temperature	T_j	115	115	$^{\circ}\text{C}$
Operating Temperature	T_{op}	-40 To +85		$^{\circ}\text{C}$
Storage Temperature	T_{stg}	-40 To +100		$^{\circ}\text{C}$
DC Forward Current	$I_F^{[2]}$	10	10	mA
Peak Forward Current	$I_{\text{FP}}^{[3]}$	50	50	mA
Electrostatic Discharge Threshold (HBM)	-	250	3000	V
Thermal Resistance (Junction / Ambient)	$R_{\text{th JA}}^{[4]}$	720	690	$^{\circ}\text{C/W}$
Thermal Resistance (Junction / Solder point)	$R_{\text{th JS}}^{[4]}$	580	530	$^{\circ}\text{C/W}$

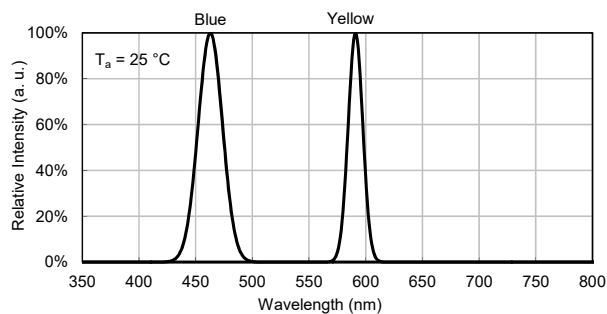
Notes:

1. Within 35mW when multiple chips are lightened
2. The maximum ratings are valid for the case of lighting a single chip
When two chips are lit at the same time, each chip should be driven at a current lower than 50% of the absolute maximum ratings
3. Duty Cycle $\leq 1/20$, Pulse Width = 1ms.
4. $R_{\text{th JA}}$, $R_{\text{th JS}}$: Results from mounting on PC board FR4 (pad size $\geq 16\text{mm}^2$ per pad).
5. Relative humidity levels maintained between 40% and 60% in production area are recommended to avoid the build-up of static electricity – Ref JEDEC/JESD625-A and JEDEC/J-STD-033.

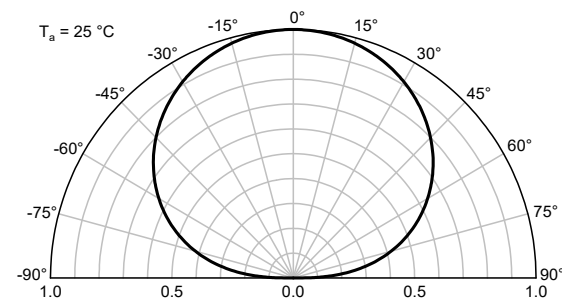


TECHNICAL DATA

RELATIVE INTENSITY vs. WAVELENGTH

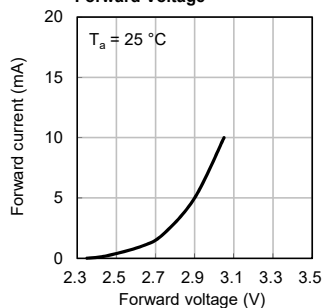


SPATIAL DISTRIBUTION

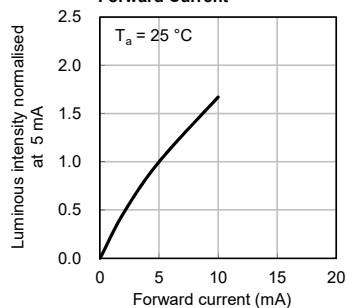


BLUE

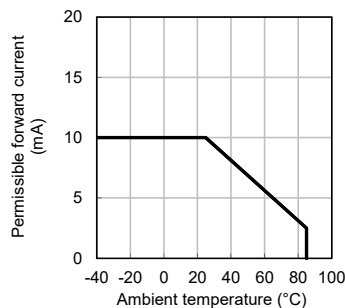
Forward Current vs. Forward Voltage



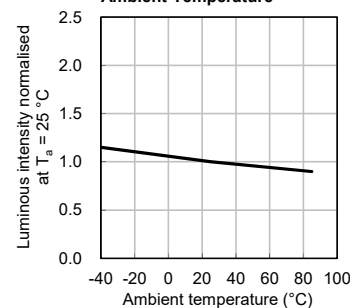
Luminous Intensity vs. Forward Current



Forward Current Derating Curve

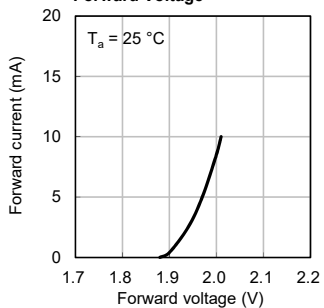


Luminous Intensity vs. Ambient Temperature

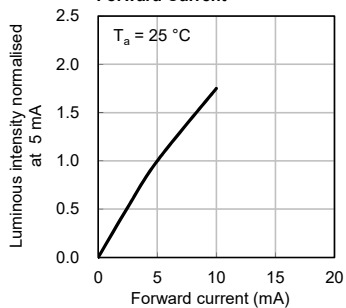


SUPER BRIGHT YELLOW

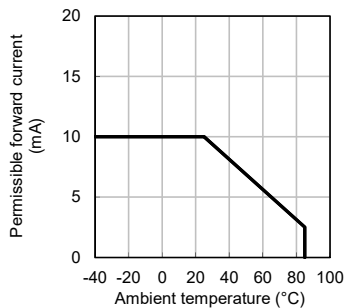
Forward Current vs. Forward Voltage



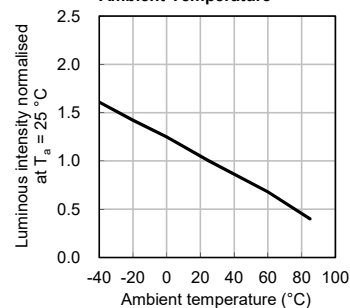
Luminous Intensity vs. Forward Current



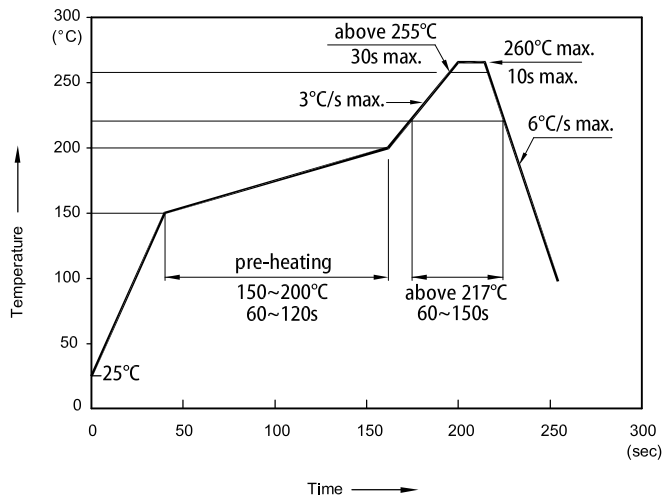
Forward Current Derating Curve



Luminous Intensity vs. Ambient Temperature



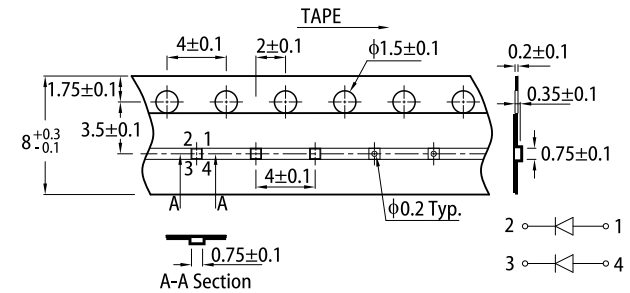
REFLOW SOLDERING PROFILE for LEAD-FREE SMD PROCESS



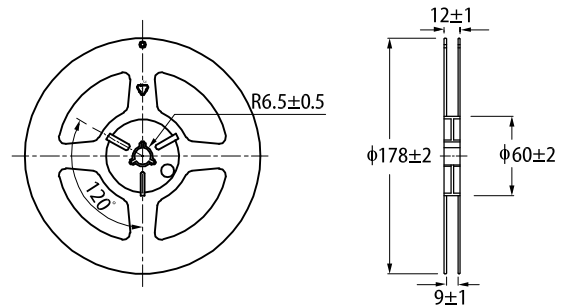
Notes:

1. Don't cause stress to the LEDs while it is exposed to high temperature.
2. The maximum number of reflow soldering passes is 2 times.
3. Reflow soldering is recommended. Other soldering methods are not recommended as they might cause damage to the product.

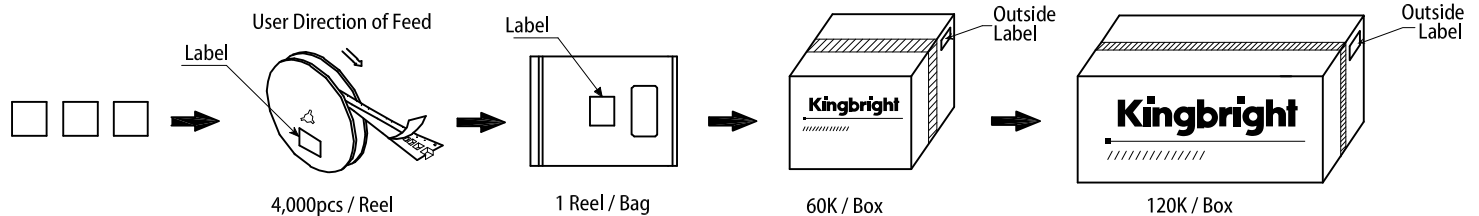
TAPE SPECIFICATIONS (units : mm)



REEL DIMENSION (units : mm)



PACKING & LABEL SPECIFICATIONS



Kingbright

XXXXXXXXXX-XXXX

P/NO: XXXXXXXX

QTY: XXXXXpcs

S/N: XXXX

CODE: XX

COUNTRY: CN

QC DATE: XXX XX XXXX PASSED

LOT NO:

XXXXXXXXXXXXXXX

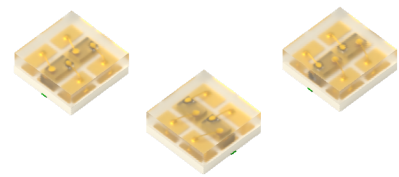
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RoHS Compliant

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KPGB-0607VBA1ZGC

0.65 x 0.65 x 0.25 mm Bi-Color Surface Mount LED

DESCRIPTIONS

- The Blue source color devices are made with InGaN on Sapphire substrate Light Emitting Diode
- The Green source color devices are made with InGaN on Sapphire Light Emitting Diode
- Electrostatic discharge and power surge could damage the LEDs
- It is recommended to use a wrist band or anti-electrostatic glove when handling the LEDs
- All devices, equipments and machineries must be electrically grounded

FEATURES

- 0.65 mm x 0.65 mm SMD LED, 0.25 mm thickness
- Low power consumption
- Package: 4000 pcs / reel
- Moisture sensitivity level: 3
- Halogen-free
- RoHS compliant

APPLICATIONS

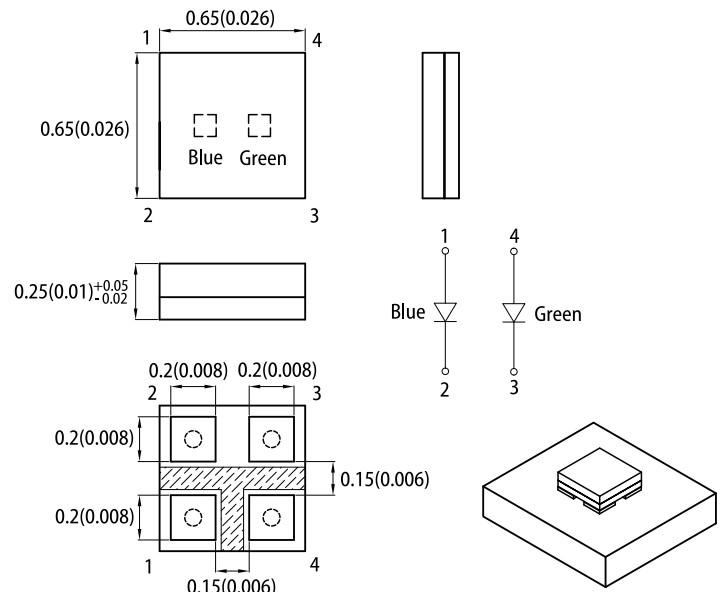
- Backlight
- Status indicator
- Home and smart appliances
- Wearable and portable devices
- Healthcare applications

ATTENTION

Observe precautions for handling electrostatic discharge sensitive devices

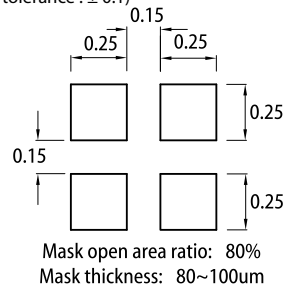


PACKAGE DIMENSIONS



RECOMMENDED SOLDERING PATTERN



(units : mm; tolerance : ± 0.1)



Notes:

1. All dimensions are in millimeters (inches).
2. Tolerance is ±0.1(0.004") unless otherwise noted.
3. The specifications, characteristics and technical data described in the datasheet are subject to change without prior notice.
4. The device has a single mounting surface. The device must be mounted according to the specifications.

SELECTION GUIDE

Part Number	Emitting Color (Material)	Lens Type	Iv (mcd) @ 5mA ^[2]		Viewing Angle ^[1]
			Min.	Typ.	2θ1/2
KPGB-0607VBA1ZGC	 Blue (InGaN)	Water Clear	10	40	140°
	 Green (InGaN)		50	200	

Notes:
 1. θ1/2 is the angle from optical centerline where the luminous intensity is 1/2 of the optical peak value.
 2. Luminous intensity / luminous flux: +/-15%.
 3. Luminous intensity value is traceable to CIE127-2007 standards.



ELECTRICAL / OPTICAL CHARACTERISTICS at T_A=25°C

Parameter	Symbol	Emitting Color	Value		Unit
			Typ.	Max.	
Wavelength at Peak Emission I _F = 5mA	λ_{peak}	Blue Green	463 515	-	nm
Dominant Wavelength I _F = 5mA	λ_{dom} ^[1]	Blue Green	468 525	-	nm
Spectral Bandwidth at 50% Φ REL MAX I _F = 5mA	$\Delta\lambda$	Blue Green	25 30	-	nm
Forward Voltage I _F = 5mA	V _F ^[2]	Blue Green	2.9 2.85	3.2 3.3	V
Reverse Current (V _R = 5V)	I _R	Blue Green	-	50 50	μA
Temperature Coefficient of λ_{peak} I _F = 5mA, -10°C ≤ T ≤ 85°C	TC _{λ_{peak}}	Blue Green	0.04 0.05	-	nm/°C
Temperature Coefficient of λ_{dom} I _F = 5mA, -10°C ≤ T ≤ 85°C	TC _{λ_{dom}}	Blue Green	0.03 0.03	-	nm/°C
Temperature Coefficient of V _F I _F = 5mA, -10°C ≤ T ≤ 85°C	TC _V	Blue Green	-3.0 -3.0	-	mV/°C

Notes:

1. The dominant wavelength (λ_d) above is the setup value of the sorting machine. (Tolerance λ_d : ±1nm.)
2. Forward voltage: ±0.1V.
3. Wavelength value is traceable to CIE127-2007 standards.
4. Excess driving current and / or operating temperature higher than recommended conditions may result in severe light degradation or premature failure.

ABSOLUTE MAXIMUM RATINGS at T_A=25°C

Parameter	Symbol	Value		Unit
		Blue	Green	
Power Dissipation	P _D ^[1]	35		mW
Reverse Voltage	V _R	5	5	V
Junction Temperature	T _j	115	115	°C
Operating Temperature	T _{op}	-40 To +85		°C
Storage Temperature	T _{stg}	-40 To +100		°C
DC Forward Current	I _F ^[2]	10	10	mA
Peak Forward Current	I _{FP} ^[3]	50	50	mA
Electrostatic Discharge Threshold (HBM)	-	250	450	V
Thermal Resistance (Junction / Ambient)	R _{th JA} ^[4]	720	780	°C/W
Thermal Resistance (Junction / Solder point)	R _{th JS} ^[4]	580	650	°C/W

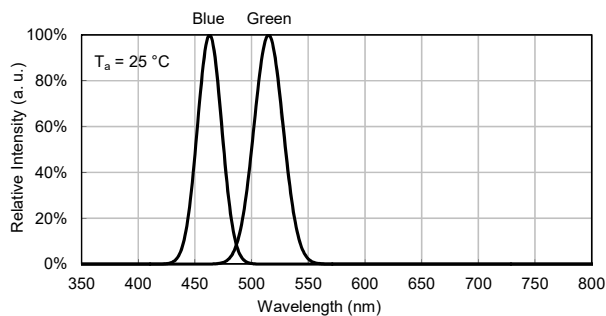
Notes:

1. Within 35mW when multiple chips are lightened
2. The maximum ratings are valid for the case of lighting a single chip
3. When two chips are lit at the same time, each chip should be driven at a current lower than 50% of the absolute maximum ratings
4. R_{th JA}, R_{th JS} Results from mounting on PC board FR4 (pad size ≥ 16 mm² per pad).
5. Relative humidity levels maintained between 40% and 60% in production area are recommended to avoid the build-up of static electricity – Ref JEDEC/JESD625-A and JEDEC/J-STD-033.

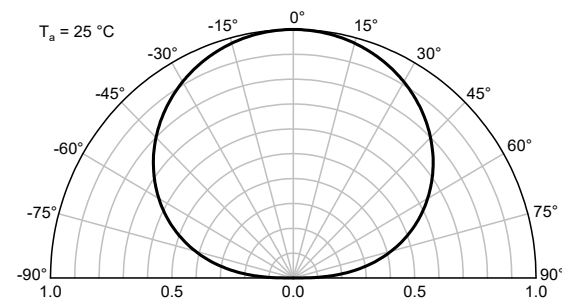


TECHNICAL DATA

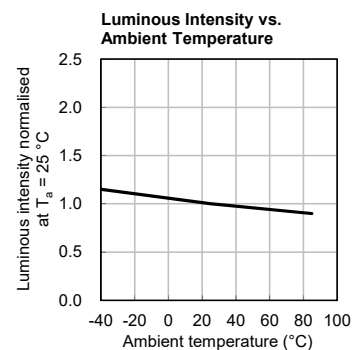
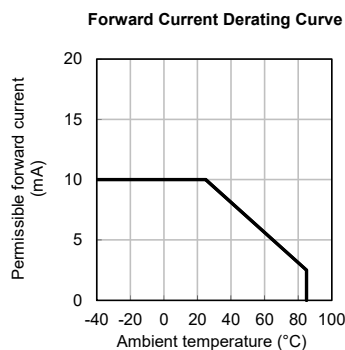
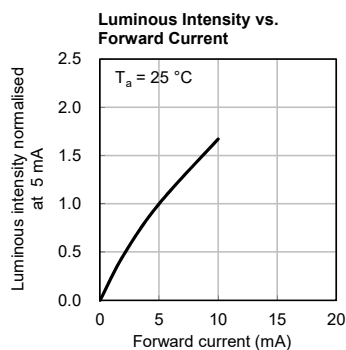
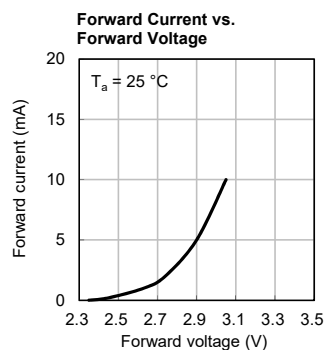
RELATIVE INTENSITY vs. WAVELENGTH



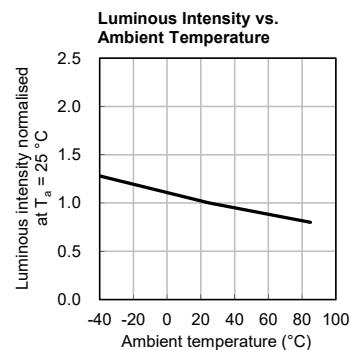
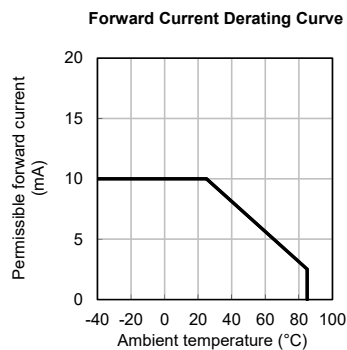
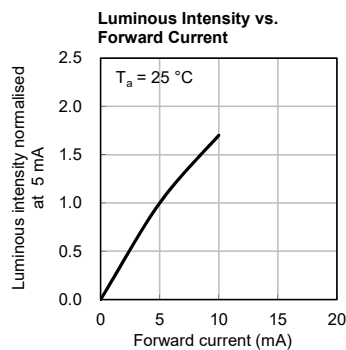
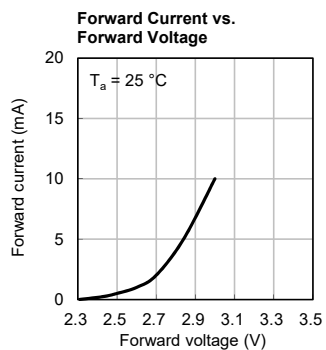
SPATIAL DISTRIBUTION



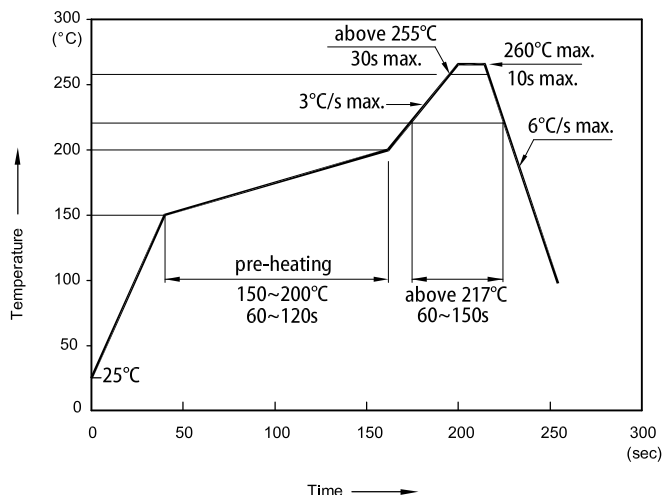
BLUE



GREEN

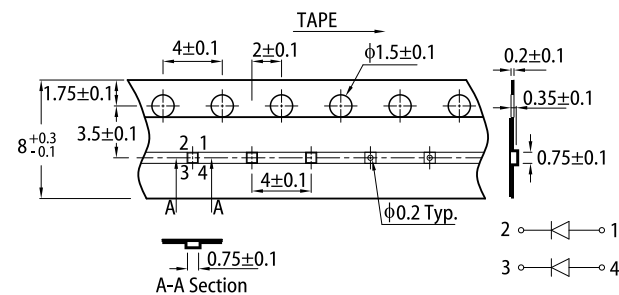


REFLOW SOLDERING PROFILE for LEAD-FREE SMD PROCESS

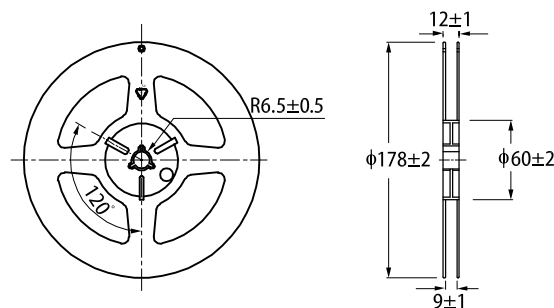


- Notes:
1. Don't cause stress to the LEDs while it is exposed to high temperature.
 2. The maximum number of reflow soldering passes is 2 times.
 3. Reflow soldering is recommended. Other soldering methods are not recommended as they might cause damage to the product.

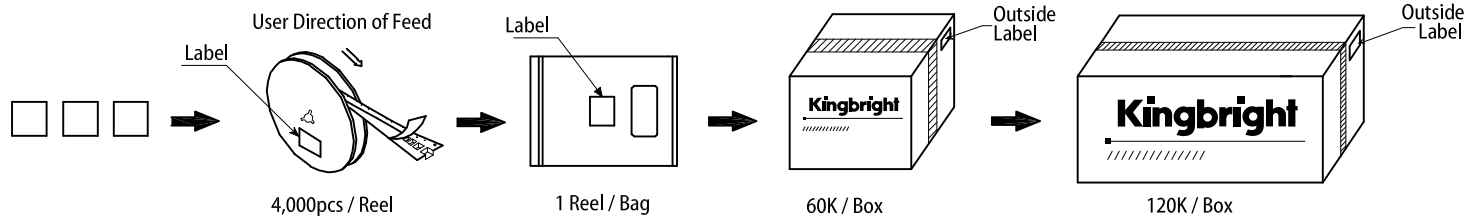
TAPE SPECIFICATIONS (units : mm)



REEL DIMENSION (units : mm)



PACKING & LABEL SPECIFICATIONS



Kingbright

XXXXXXXXXX-XXXX

P/NO: XXXXXXXX

QTY: XXXXXpcs

S/N: XXXX

CODE: XX

COUNTRY: CN

QC DATE: XXX XX XXXX PASSED

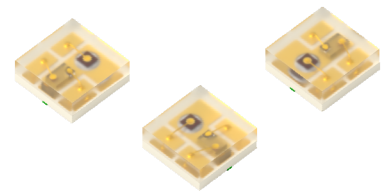
LOT NO:

(SP)XXXXXXXXXX

RoHS Compliant

PRECAUTIONARY NOTES

1. The information included in this document reflects representative usage scenarios and is intended for technical reference only.
2. The part number, type, and specifications mentioned in this document are subject to future change and improvement without notice. Before production usage customer should refer to the latest datasheet for the updated specifications.
3. When using the products referenced in this document, please make sure the product is being operated within the environmental and electrical limits specified in the datasheet. If customer usage exceeds the specified limits, Kingbright will not be responsible for any subsequent issues.
4. The information in this document applies to typical usage in consumer electronics applications. If customer's application has special reliability requirements or have life-threatening liabilities, such as automotive or medical usage, please consult with Kingbright representative for further assistance.
5. The contents and information of this document may not be reproduced or re-transmitted without permission by Kingbright.
6. All design applications should refer to Kingbright application notes available at https://www.kingbright.com/application_notes



KPGB-0607ZGSEEKKC-TT

0.65 x 0.65 x 0.25 mm Bi-Color Surface Mount LED

DESCRIPTIONS

- The Green source color devices are made with InGaN on Sapphire Light Emitting Diode
- The Hyper-Red source color devices are made with AlGaInP on GaAs substrate Light Emitting Diode
- Electrostatic discharge and power surge could damage the LEDs
- It is recommended to use a wrist band or anti-electrostatic glove when handling the LEDs
- All devices, equipments and machineries must be electrically grounded

FEATURES

- 0.65 mm x 0.65 mm SMD LED, 0.25 mm thickness
- Low power consumption
- Package: 4000 pcs / reel
- Moisture sensitivity level: 3
- Halogen-free
- RoHS compliant

APPLICATIONS

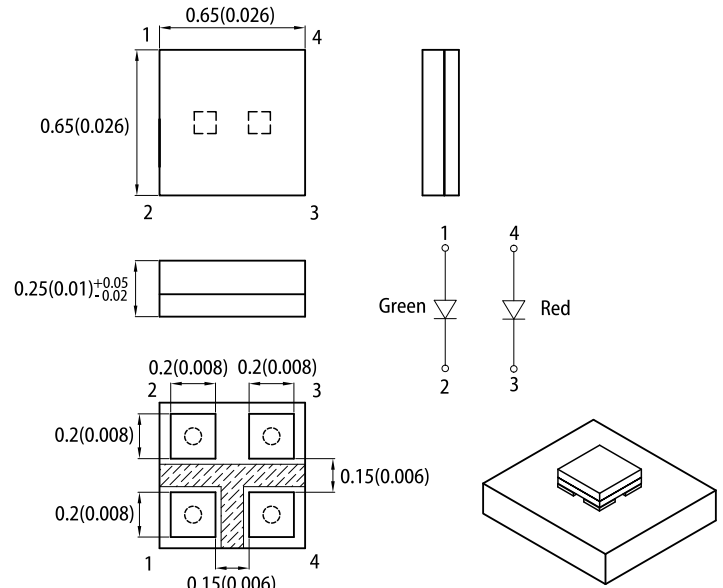
- Backlight
- Status indicator
- Home and smart appliances
- Wearable and portable devices
- Healthcare applications

ATTENTION

Observe precautions for handling electrostatic discharge sensitive devices

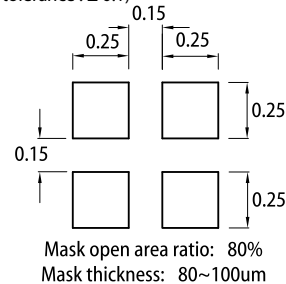


PACKAGE DIMENSIONS



RECOMMENDED SOLDERING PATTERN

(units : mm; tolerance : ± 0.1)



Notes:

1. All dimensions are in millimeters (inches).
2. Tolerance is $\pm 0.1(0.004)$ unless otherwise noted.
3. The specifications, characteristics and technical data described in the datasheet are subject to change without prior notice.
4. The device has a single mounting surface. The device must be mounted according to the specifications.

SELECTION GUIDE

Part Number	Emitting Color (Material)	Lens Type	Iv (mcd) @ 5mA ^[2]		Viewing Angle ^[1]
			Min.	Typ.	2θ1/2
KPGB-0607ZGSEEKKC-TT	Green (InGaN)	Water Clear	50	200	140°
			*50	*200	
	Hyper Red (AlGaInP)		15	75	
			*6	*25	

Notes:
 1. $\theta_{1/2}$ is the angle from optical centerline where the luminous intensity is 1/2 of the optical peak value.
 2. Luminous intensity / luminous flux: $\pm 15\%$.
 * Luminous intensity value is traceable to CIE127-2007 standards.



ELECTRICAL / OPTICAL CHARACTERISTICS at T_A=25°C

Parameter	Symbol	Emitting Color	Value		Unit
			Typ.	Max.	
Wavelength at Peak Emission I _F = 5mA	λ_{peak}	Green Hyper Red	515 632	-	nm
Dominant Wavelength I _F = 5mA	$\lambda_{\text{dom}}^{[1]}$	Green Hyper Red	525 624	-	nm
Spectral Bandwidth at 50% Φ REL MAX I _F = 5mA	$\Delta\lambda$	Green Hyper Red	30 20	-	nm
Forward Voltage I _F = 5mA	V _F ^[2]	Green Hyper Red	2.85 1.95	3.3 2.3	V
Reverse Current (V _R = 5V)	I _R	Green Hyper Red	-	50 10	μA
Temperature Coefficient of λ_{peak} I _F = 5mA, -10°C ≤ T ≤ 85°C	TC _{λ_{peak}}	Green Hyper Red	0.05 0.13	-	nm/°C
Temperature Coefficient of λ_{dom} I _F = 5mA, -10°C ≤ T ≤ 85°C	TC _{λ_{dom}}	Green Hyper Red	0.03 0.06	-	nm/°C
Temperature Coefficient of V _F I _F = 5mA, -10°C ≤ T ≤ 85°C	TC _V	Green Hyper Red	-3.0 -1.9	-	mV/°C

Notes:

1. The dominant wavelength (λ_d) above is the setup value of the sorting machine. (Tolerance λ_d : ±1nm.)
2. Forward voltage: ±0.1V.
3. Wavelength value is traceable to CIE127-2007 standards.
4. Excess driving current and / or operating temperature higher than recommended conditions may result in severe light degradation or premature failure.

ABSOLUTE MAXIMUM RATINGS at T_A=25°C

Parameter	Symbol	Value		Unit
		Green	Hyper Red	
Power Dissipation	P _D ^[1]	35		mW
Reverse Voltage	V _R	5	5	V
Junction Temperature	T _j	115	115	°C
Operating Temperature	T _{op}	-40 To +85		°C
Storage Temperature	T _{stg}	-40 To +100		°C
DC Forward Current	I _F ^[2]	10	10	mA
Peak Forward Current	I _{FP} ^[3]	50	40	mA
Electrostatic Discharge Threshold (HBM)	-	450	3000	V
Thermal Resistance (Junction / Ambient)	R _{th JA} ^[4]	780	650	°C/W
Thermal Resistance (Junction / Solder point)	R _{th JS} ^[4]	650	480	°C/W

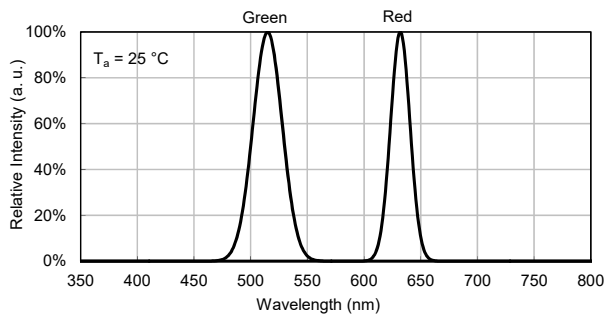
Notes:

1. Within 35mW when multiple chips are lightened
2. The maximum ratings are valid for the case of lighting a single chip
When two chips are lit at the same time, each chip should be driven at a current lower than 50% of the absolute maximum ratings
3. Duty Cycle ≤ 1 / 20, Pulse Width = 1ms.
4. R_{th JA}, R_{th JS}: Results from mounting on PC board FR4 (pad size ≥ 16 mm² per pad).
5. Relative humidity levels maintained between 40% and 60% in production area are recommended to avoid the build-up of static electricity – Ref JEDEC/JESD625-A and JEDEC/J-STD-033.

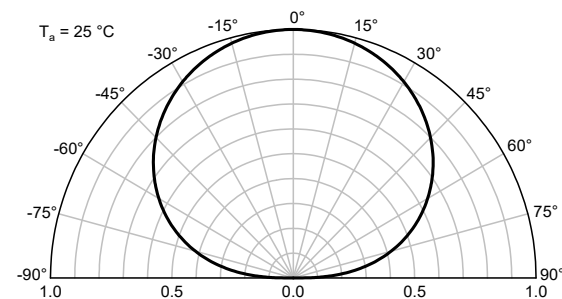


TECHNICAL DATA

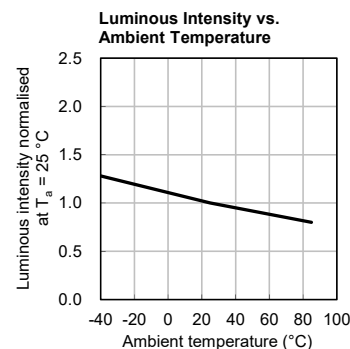
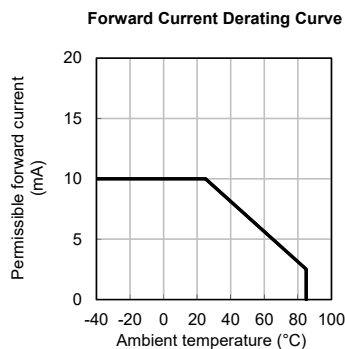
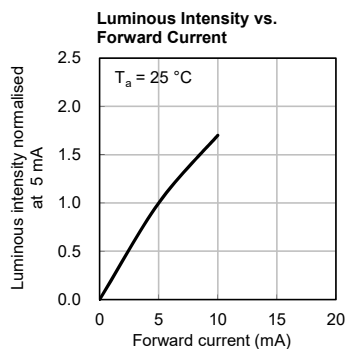
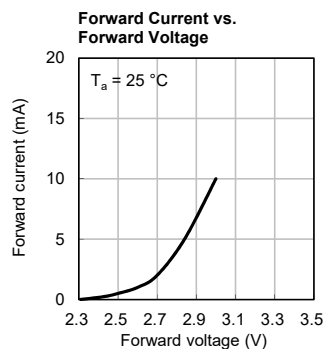
RELATIVE INTENSITY vs. WAVELENGTH



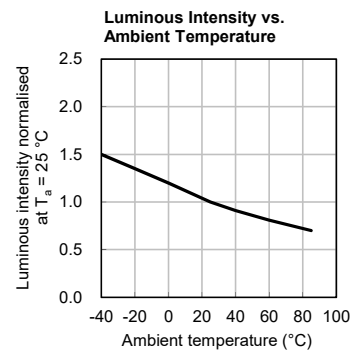
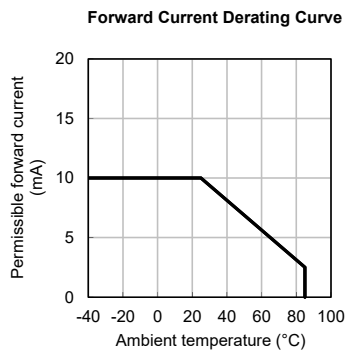
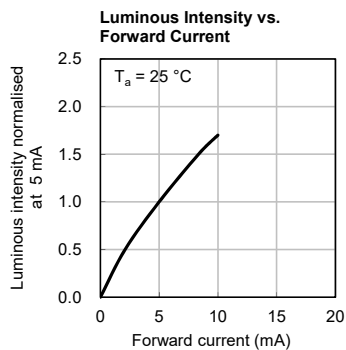
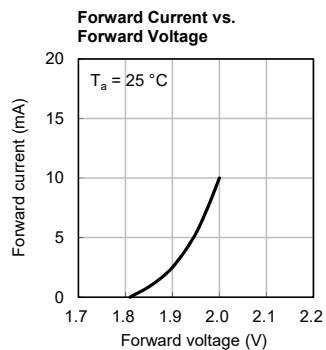
SPATIAL DISTRIBUTATION



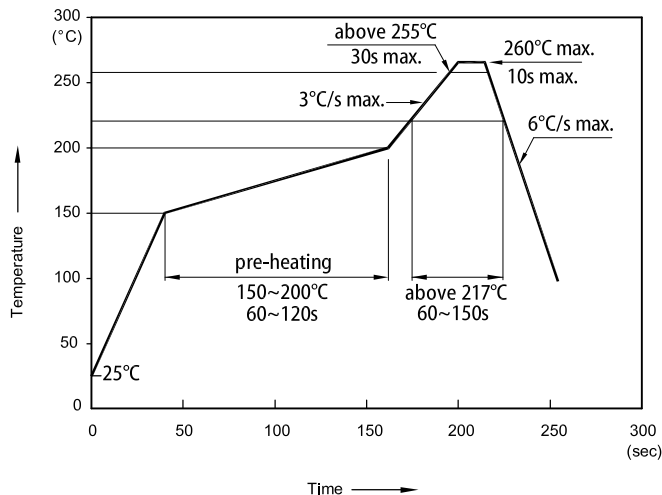
GREEN



HYPER RED



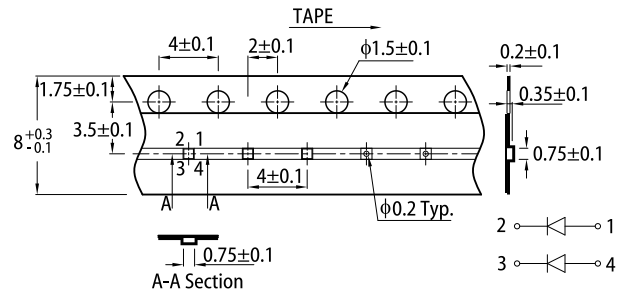
REFLOW SOLDERING PROFILE for LEAD-FREE SMD PROCESS



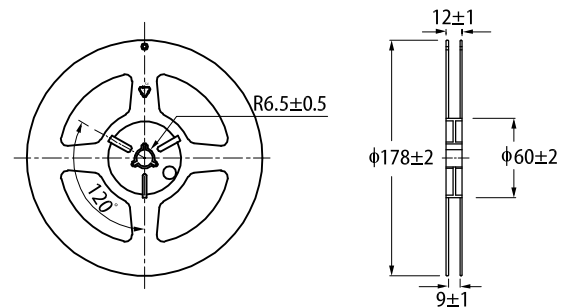
Notes:

1. Don't cause stress to the LEDs while it is exposed to high temperature.
2. The maximum number of reflow soldering passes is 2 times.
3. Reflow soldering is recommended. Other soldering methods are not recommended as they might cause damage to the product.

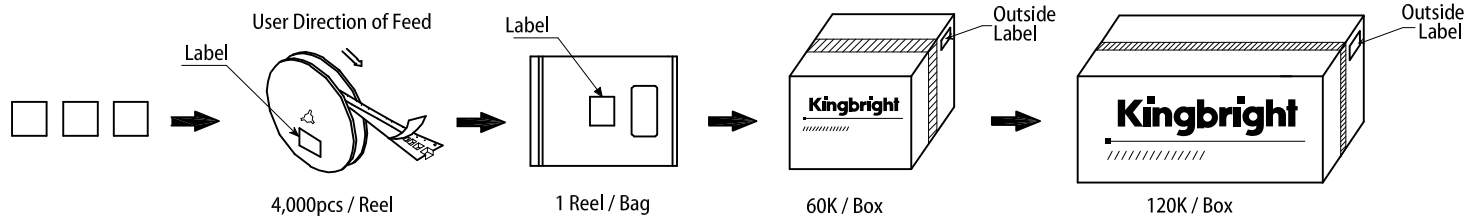
TAPE SPECIFICATIONS (units : mm)



REEL DIMENSION (units : mm)



PACKING & LABEL SPECIFICATIONS



Kingbright

XXXXXXXXXX-XXXX

P/NO: XXXXXXXXX

QTY: XXXXXpcs

S/N: XXXX

CODE: XX

COUNTRY: CN

QC DATE: XXX XX XXXX PASSED

LOT NO:

(SP)XXXXXXXXXX

RoHS Compliant

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